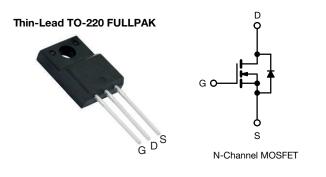
# SiHA240N60E

**Vishay Siliconix** 



## **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.208				
Q <sub>g</sub> max. (nC)	23				
Q <sub>gs</sub> (nC)	4				
Q <sub>gd</sub> (nC)	6				
Configuration	Single				

## **FEATURES**

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C<sub>o(er)</sub>)
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION					
Package	Thin-Lead TO-220 FULLPAK				
Lead (Pb)-free and halogen-free	SiHA240N60E-GE3				

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	- V	
Gate-source voltage			V <sub>GS</sub>	± 30		
Continuous drain surrant (T 150 °C) f	$T_{\rm C} = 25 ^{\circ}{\rm C}$		1	12		
Continuous drain current ( $T_J = 150 \text{ °C}$ ) <sup>e</sup>	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	I <sub>D</sub>	7	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	30	1	
Linear derating factor				0.63	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	81	mJ	
Maximum power dissipation			PD	31	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$		dv/dt	100	V/ns		
Reverse diode dv/dt d			uv/di			28
Soldering recommendations (peak temperature	e) <sup>c</sup>	For 10 s		260	°C	
Mounting torque, M3 screw				0.6	Nm	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 2.4 A
- c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, di/dt$  = 100 A/µs, starting  $T_J$  = 25  $^\circ C$ 

e. Limited by maximum junction temperature

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COMPLIANT HALOGEN



THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-		65		°C ///		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 4.0			°C/W			
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	$V_{GS} = 0 V, I_D = 250 \mu A$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.63	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	3.0	-	5.0	V
Cata agurag lagkaga		N N	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	, v	V <sub>GS</sub> = ± 30	V	-	-	± 1	μA
Zaus ante voltano dusia sumant		V <sub>DS</sub> =	600 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V	′, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	١ <sub>c</sub>	<sub>0</sub> = 5.5 A	-	0.208	0.240	Ω
Forward transconductance a	g <sub>fs</sub>	V <sub>DS</sub> =	= 20 V, I <sub>D</sub> =	5.5 A	-	4	-	S
Dynamic					•	•	•	
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	783	-	pF	
Output capacitance	C <sub>oss</sub>			-	50	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	5	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	32	-		
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	187	-		
Total gate charge	Qg				-	15	23	1
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 5.5 A, V <sub>DS</sub> = 480 V		-	4	-	nC	
Gate-drain charge	Q <sub>gd</sub>				-	6	-	1
Turn-on delay time	t <sub>d(on)</sub>				-	15	30	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 480 \; \text{V}, \; I_{\text{D}} = 5.5 \; \text{A}, \\ V_{\text{GS}} = 10 \; \text{V}, \; R_{\text{g}} = 9.1 \; \Omega \end{array}$		-	14	28	ns
Turn-off delay time	t <sub>d(off)</sub>				-	26	52	
Fall time	t <sub>f</sub>			-	14	28		
Gate input resistance	Rg	f = 1 MHz, open drain		0.8	1.5	3.0	Ω	
Drain-Source Body Diode Characterist	ics				•	•	•	
Continuous source-drain diode current	IS	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12		
Pulsed diode forward current	I <sub>SM</sub>			-	-	30	A	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 5.5 A	, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>		-		-	209	418	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 5.5 \text{ A},$ di/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	2.1	4.2	μC	
Reverse recovery current	I <sub>RRM</sub>			-	18	-	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 





## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

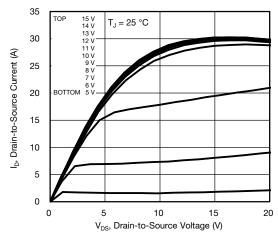
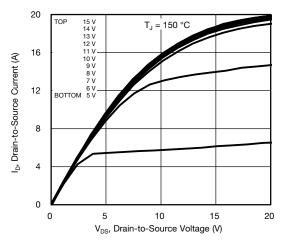


Fig. 1 - Typical Output Characteristics





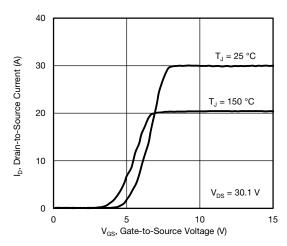


Fig. 3 - Typical Transfer Characteristics

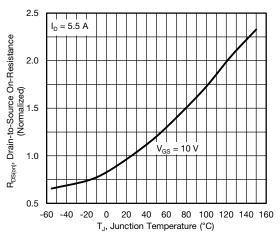


Fig. 4 - Normalized On-Resistance vs. Temperature

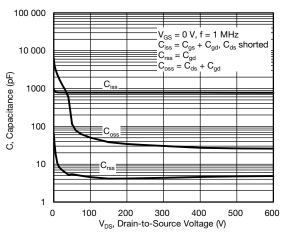


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

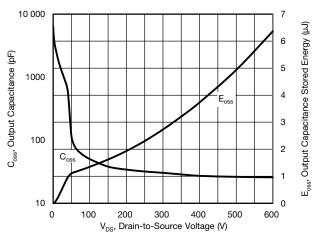


Fig. 6 -  $C_{\text{oss}}$  and  $E_{\text{oss}}$  vs.  $V_{\text{DS}}$ 

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SiHA240N60E

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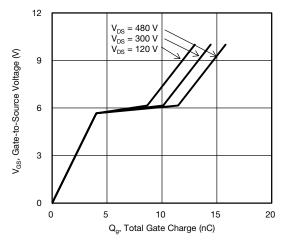


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

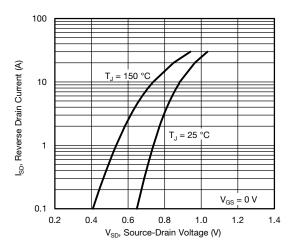


Fig. 8 - Typical Source-Drain Diode Forward Voltage

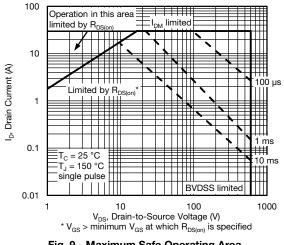


Fig. 9 - Maximum Safe Operating Area

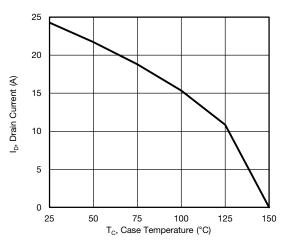


Fig. 10 - Maximum Drain Current vs. Case Temperature

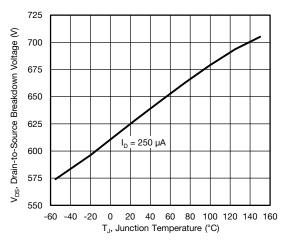
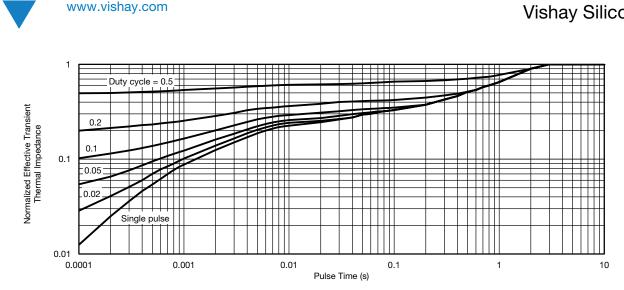
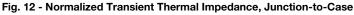


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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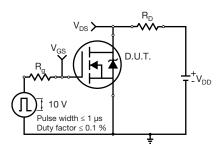


Fig. 13 - Switching Time Test Circuit

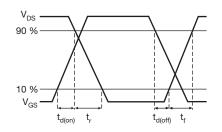


Fig. 14 - Switching Time Waveforms

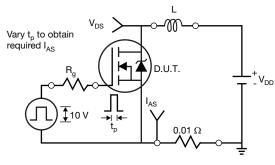


Fig. 15 - Unclamped Inductive Test Circuit

V<sub>DD</sub> VDS AS

Fig. 16 - Unclamped Inductive Waveforms

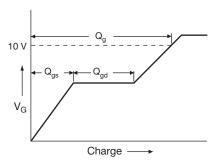


Fig. 17 - Basic Gate Charge Waveform

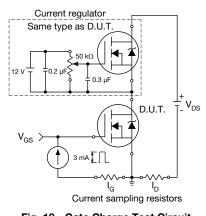


Fig. 18 - Gate Charge Test Circuit

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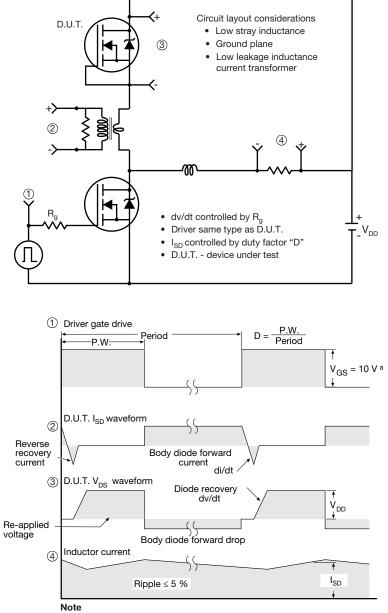
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#### Peak Diode Recovery dv/dt Test Circuit



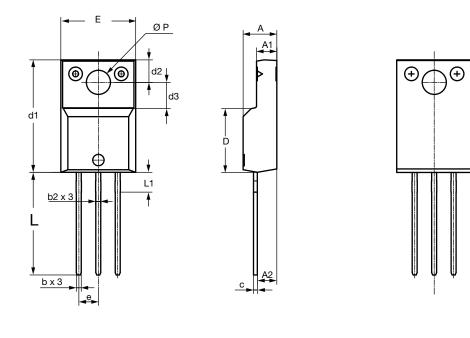
a.  $V_{GS} = 5$  V for logic level devices

Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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